Interfacing the Dual Port DP8422A to the TMS320C30 and the VME Bus

National Semiconductor Application Note 642 Lawson Chang June 1989



INTRODUCTION

This application note describes how to interface the TMS320C30 Digital Signal Processor (DSP) and the VME bus to the DP8422A DRAM Controller. This system is running at 16 MHz. It is assumed that the reader is familiar with the DP8422A, TMS320C30, and VME bus operations.

This design consists of Port A of the DP8422A interfaced to the primary bus of TMS320C30 DSP and Port B interfaced to the VME bus. The DP8422A is operated in access Mode 1 and uses the interleaving capability on chip. A Port A access cycle begins when the TMS320C30 places a valid address on the address bus and asserts the strobe (/STRB) signal, only if a refresh or Port B (VME bus) access is not in progress. GRANTB of the DP8422A indicates which port is currently granted to do an access. Port A is the default port upon power up. This design accommodates 4 banks of DRAM (256K x 4), 32 bits in each bank, giving maximum memory capacity of 4M bytes. The schematic diagram is shown in Figure 1 and simple timing diagrams are shown in Figures 2 and 3.

PROGRAMMING MODE AND BITS

Programming the DP8422A is on the first TMS320C30 DSP write after power up. 60 ms initialization period is needed right after this chip access write access programming.

Programming Bits

u = user defined, x = don't care.

R0, R1 = u, u

R2, R3 = u, u

R4, R5, R6 = x, x, x

R7 = 1

R8 = 0

R9 = u

C0, C1, C2 = 0.1.0 (16 MHz)

C3 = 0

C4, C5, C6 = u, u, u (or 0, 1, 1)

C7, C8 = u, u

C9 = 1

B0 = 0

B1 = 1

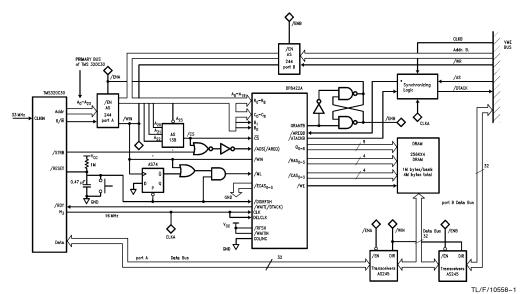
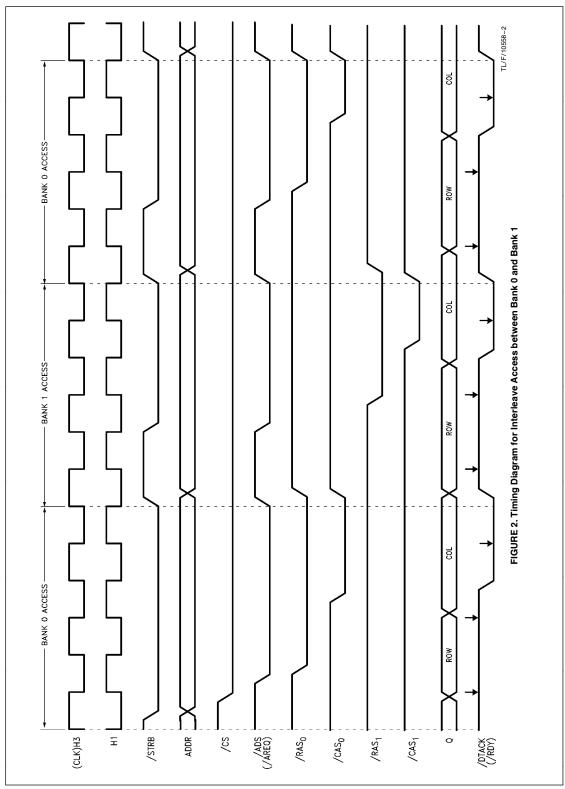
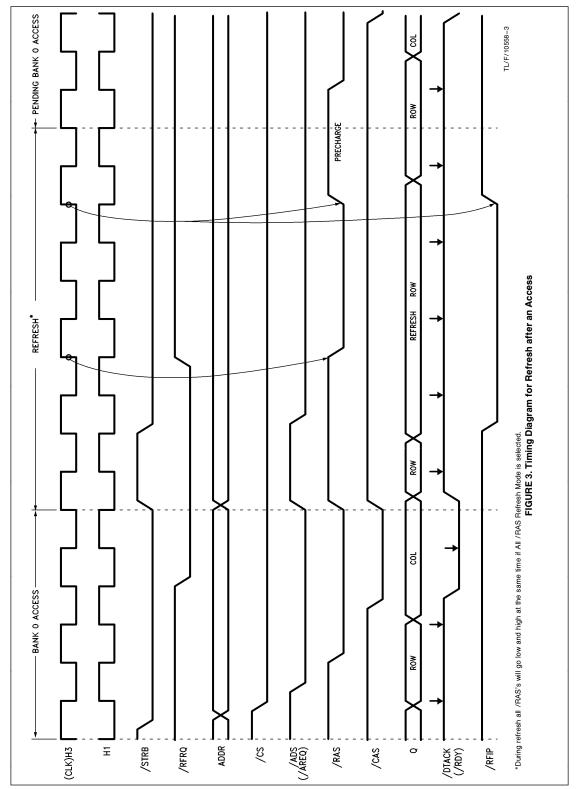


FIGURE 1. Interfacing DP8422A/TMS320C30 Schematic Diagram (Interleave Mode)

*Please refer to Interfacing the DP8422A to an Asychronous Port B in a Dual 68020 System application note.





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